

RF Transformer

TT25-1-X65

50Ω

0.02 to 30 MHz



CASE STYLE: X65

Maximum Ratings

Operating Temperature	-20°C to 85°C
Storage Temperature	55°C to 100°C
RF Power	250mW
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

PRIMARY DOT	4
PRIMARY	6
PRIMARY CT	5
SECONDARY DOT	3
SECONDARY	1
SECONDARY CT	2

Features

- excellent return loss
- also available with flat-pack (W38) & surface mount gull-wing (KK81) leads

Applications

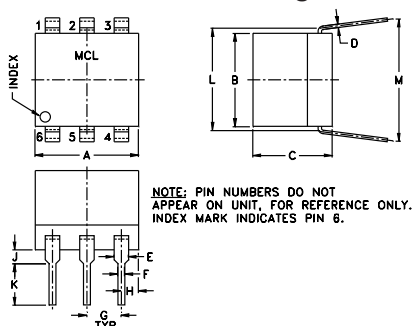
- HF
- radio communication systems
- impedance matching
- ham radio

Transformer Electrical Specifications

Ω RATIO (Secondary/Primary)	FREQUENCY (MHz)	INSERTION LOSS*		
		3 dB MHz	2 dB MHz	1 dB MHz
25	0.02-30	0.02-30	0.05-20	0.1-10

* Below 0.05 MHz, Insertion Loss is specified for room temperature and above.

Outline Drawing



Outline Dimensions (inch)

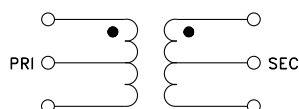
A	B	C	D	E	F	G
.30	.27	.23	.010	.042	.020	.100
7.62	6.86	5.84	0.25	1.07	0.51	2.54

H	J	K	L	M	wt
.05	.04	.11	.300	.35	grams
1.27	1.02	2.79	7.62	8.89	0.50

Typical Performance Data

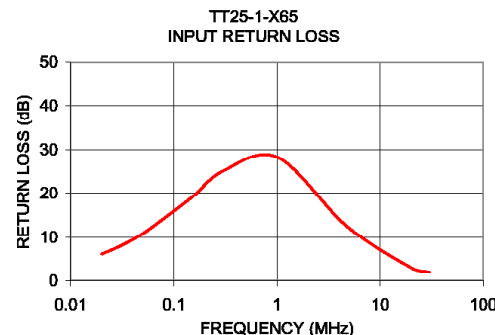
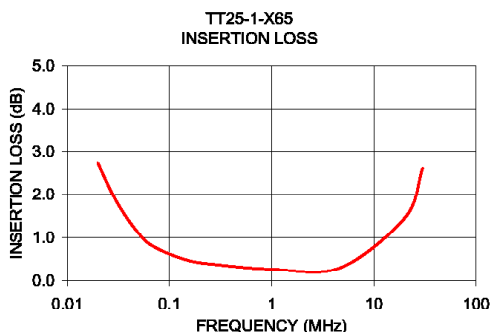
FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.02	2.72	6.13
0.03	1.86	7.95
0.05	1.18	10.45
0.07	0.80	13.16
0.15	0.48	19.05
0.30	0.37	25.11
1.01	0.27	28.34
4.66	0.30	12.69
20.13	1.46	2.94
30.00	2.60	2.00

Config. B



Notes

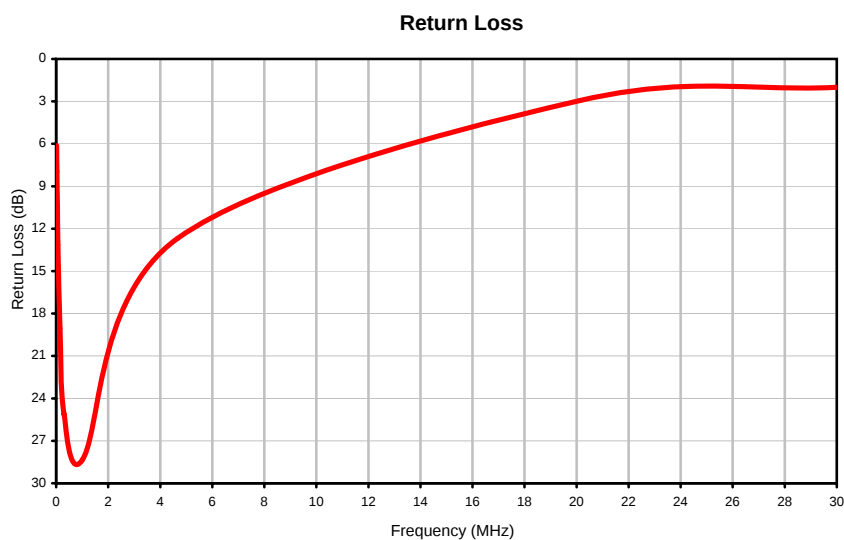
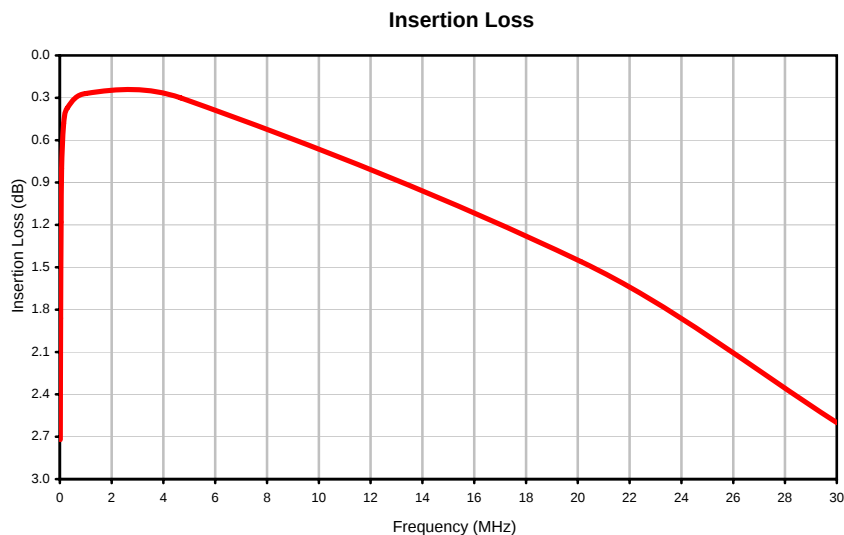
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Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.02	2.72	6.13
0.03	1.86	7.95
0.05	1.18	10.45
0.07	0.80	13.16
0.15	0.48	19.05
0.30	0.37	25.11
1.01	0.27	28.34
4.66	0.30	12.69
20.13	1.46	2.94
30.00	2.60	2.00

Typical Performance Curves



Outline Dimensions

X65



CASE #	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAM
X65	.30 (7.62)	.27 (6.86)	.23 (5.84)	.010 (0.25)	.042 (1.07)	.020 (0.51)	.100 (2.54)	.05 (1.27)	.04 (1.02)	.11 (2.79)	.300 (7.62)	.35 (8.89)	.50

Dimensions are in inches (mm)

Notes:

- Case material: Plastic.
Termination finish: For RoHS Case Styles: Tin Plate over Nickel Plate.
For RoHS-5 Case Styles: Tin-Lead Plate.



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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Lead Integrity	2 Pound Pull, perpendicular to edge of unit	MIL-STD-202, Method 211, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215